

Memory Module Specification

KVR1333D3N9/1G

1GB 128M x 64-Bit PC3-10600 CL9 240-Pin DIMM

DESCRIPTION:

This document describes ValueRAM's 128M x 64-bit 1GB (1024MB) DDR3-1333 CL9 SDRAM (Synchronous DRAM) memory module, based on eight 128M x 8-bit DDR3-1333 FBGA components. The SPD is programmed to JEDEC standard latency 1333Mhz timing of 9-9-9 at 1.5V. This 240-pin DIMM uses gold contact fingers and requires +1.5V. The electrical and mechanical specifications are as follows:

FEATURES:

JEDEC standard $1.5V \pm 0.075V$ Power Supply

☑ VDDQ = 1.5V ± 0.075V

☑ 667MHz fCK for 1333Mb/sec/pin

8 independent internal bank

Programmable CAS Latency: 5,6,7,8,9,10

Posted CAS

Programmable Additive Latency: 0, CL - 2, or CL - 1 clock

Programmable CAS Write Latency(CWL) = 9(DDR3-1333)

8-bit pre-fetch

Burst Length: 8 (Interleave without any limit, sequential with starting address "000" only), 4 with tCCD = 4 which does not allow seamless read or write [either on the fly using A12 or MRS]

Bi-directional Differential Data Strobe

☐ Internal(self) calibration : Internal self calibration through ZQ pin (RZQ : 240 ohm ± 1%)

On Die Termination using ODT pin

Average Refresh Period 7.8us at lower then TCASE 85°C, 3.9us at 85°C < TCASE . 95°C

Asynchronous Reset

1066Mbps CL7 doesn't have backward compatibility with 800Mbps CL5

PCB: Height 1.180" (30.00mm), single sided component

PERFORMANCE:

CL(IDD)
9 cycles
Row Cycle Time (tRCmin)
49.5ns (min.)
Refresh to Active/Refresh Command Time (tRFCmin)
110ns
Row Active Time (tRASmin)
36ns (min.)
Power
1.296 W (operating)
UL Rating
94 V - 0
Operating Temperature
0° C to 85° C

Storage Temperature

-55° C to +100° C

MODULE DIMENSIONS:





